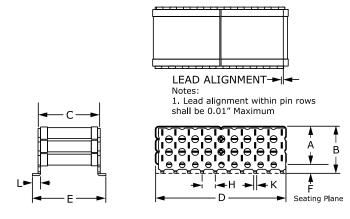


L1GL30G124KA06

KPS-MCC Indust COG HT200C, Ceramic, 0.12 uF, 10%, 2,000 VDC, COG



Click here for the 3D model.

General Information	
Series	KPS-MCC Indust COG HT200C
Style	Leaded Stacked Chip
Description	Low ESR, Stacked Ceramic Chips
Features	200C, Low ESR, High Thermal Stability, Bulk Capacitance
RoHS	With Exemptions
REACH	SVHC (Pb - CAS 7439-92-1)
SCIP Number	297427bb-2a48-4853-b594-64 1304a2cc24
Termination	Silver
Lead	L Leads
AEC-Q200	No
Notes	Number of chips in this stack: 6.

Dimensions	
D	25.64mm +/-0.635mm
L	1.4mm +/-0.127mm
н	2.54mm NOM
F	1.778mm +/-0.25mm
A	8.13mm MAX
В	10.162mm MAX
С	11.43mm +/-0.635mm
E	13.7mm +/-0.89mm
К	0.5mm NOM

Packaging Specifications	
Packaging	Waffle, Box
Packaging Quantity	16

Specifications	
Capacitance	0.12 uF
Tolerance	10%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2,400 VDC
Temperature Range	-55/+200°C
Temp. Coefficient	COG
Dissipation Factor	0.1% 1 kHz 25C
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	8.33 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.